

		1						
LOC	DIST	REVISIONS						
H	—	P	LTR	DESCRIPTION		DATE	DWN	APVD
			L	REVISED PER ECO-13-014710		07NOV2013	SY	FY

NOTES:

- 1

MATERIAL CONTACTS; PHOSPHORBRONZE
- 2

MATERIAL HOUSING; GLASSFILLED POLYESTER (GRAY)
- 3

GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1,27µm NICKEL MIN. AND ACTION PIN: 0,5µm TIN-LEAD MIN. FOR PLATING OF MATING SURFACES SEE APPLICABLE SPECIFICATION REFERENCE FOR EACH DASH NUMBER.
- 4

CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 2.
- 5

CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 1.
- 6

CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL III, CENTRAL OFFICE APPLICATIONS.
- 8

CONNECTOR LUBRICATED WITH TELCORDIA APPROVED LUBRICANT.
- 9

ASSEMBLY PRINTED WITH P/N AND DATECODE
- 10

THE MARKING CAN APPEAR ON THE FRONT SIDE OR BACK SIDE.
- 11

HOLE PATTERN FOR FEMALE CONNECTOR TYPE B-22 COLUMNS 110 PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID
- 12

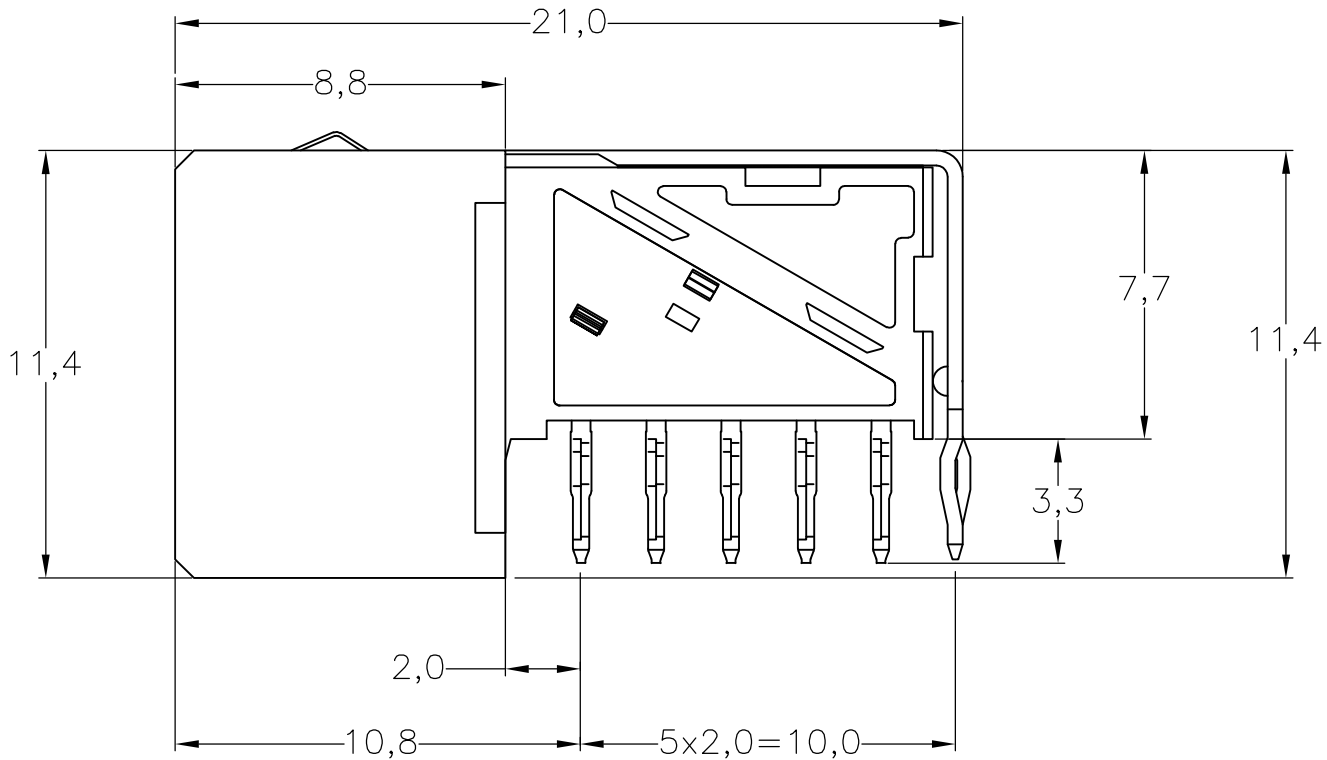
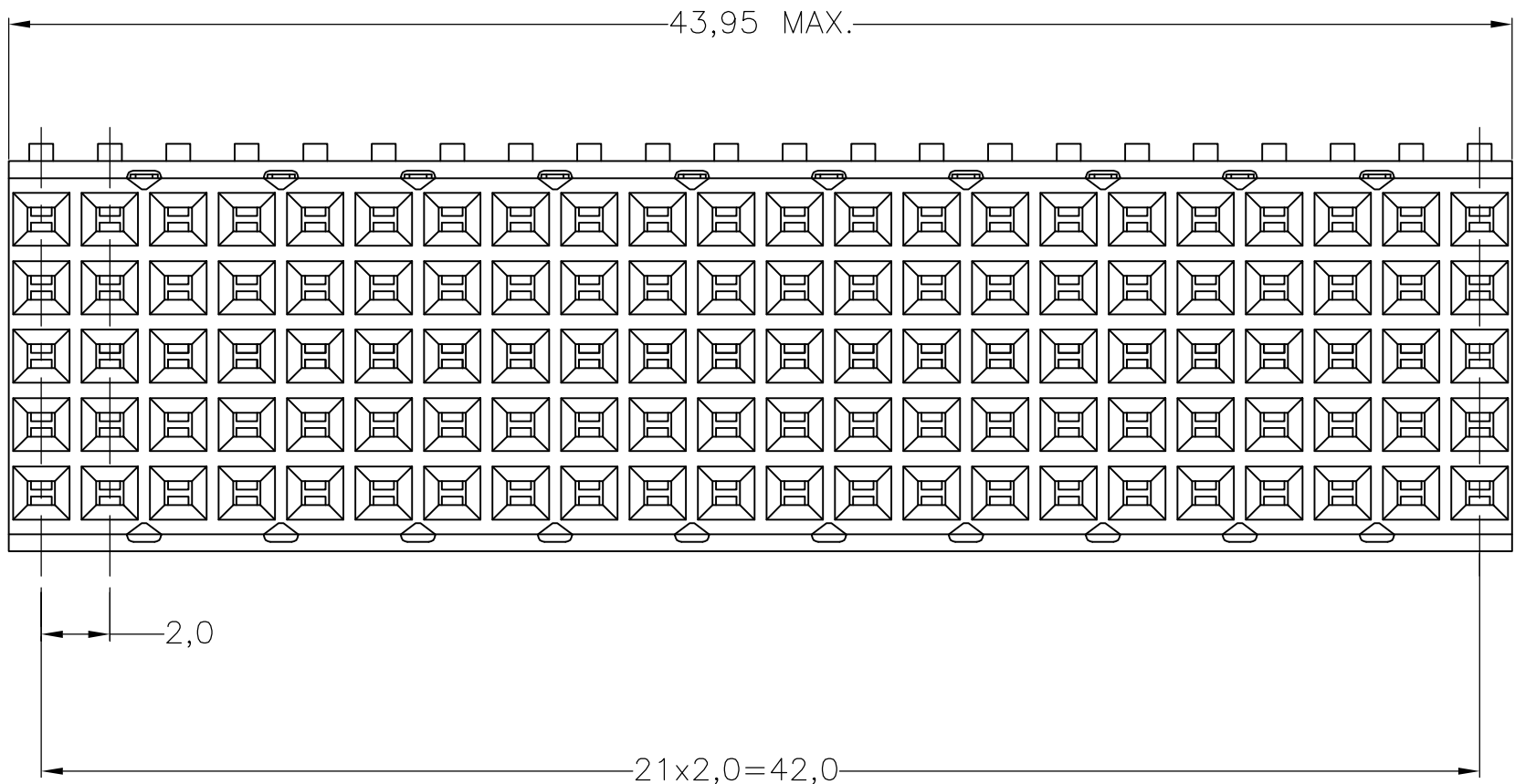
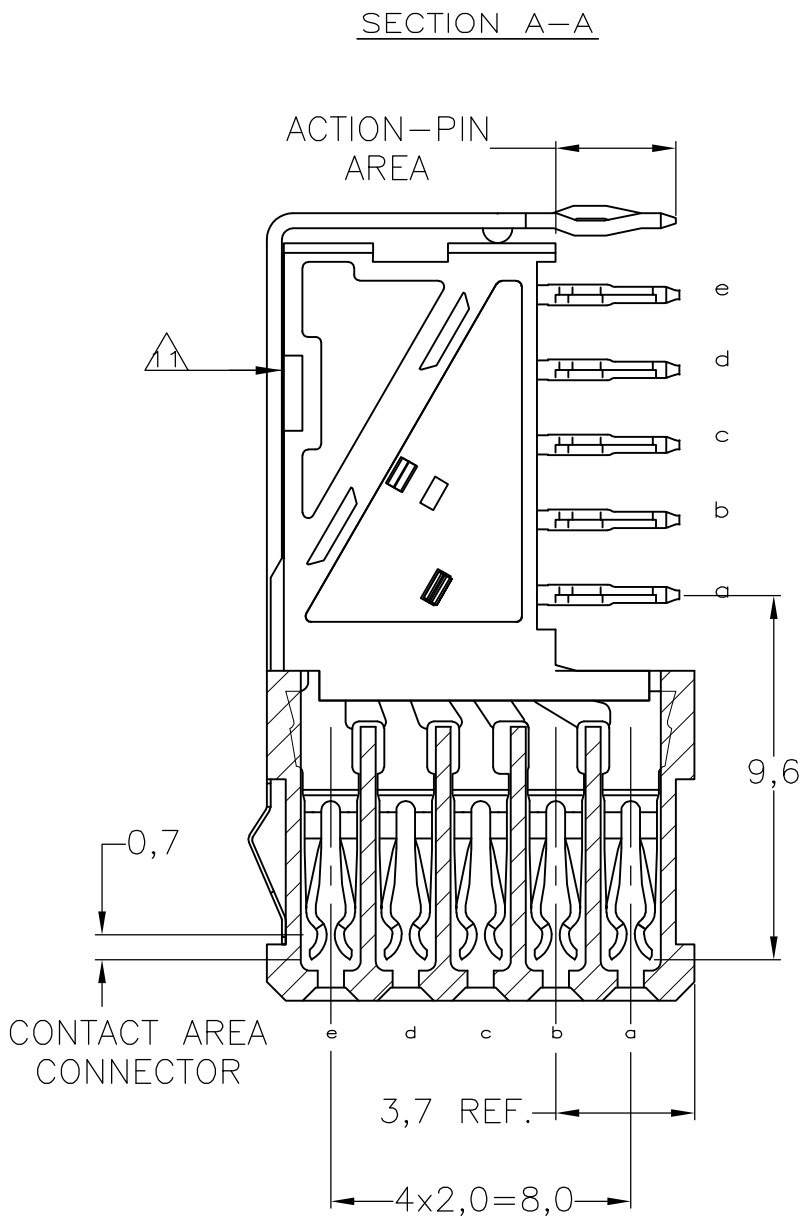
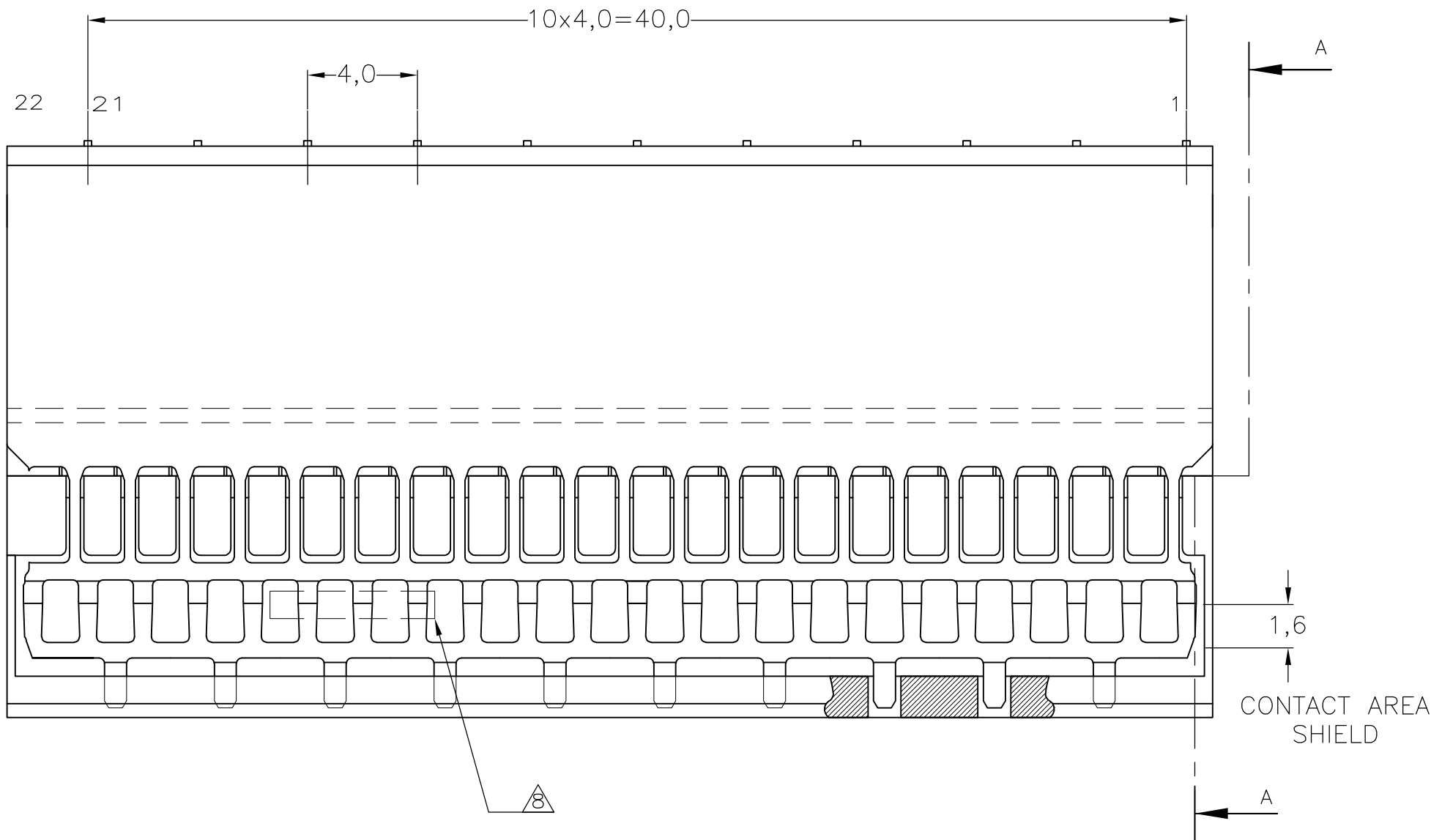
ROW "f" 11 PLATED THROUGH HOLES FOR UPPERSHIELD
- 13

SHIELD MOUNTED ON CONNECTOR WITH DOUBLE SIDED ADHESIVE TAPE OR ADHESIVE
- 14

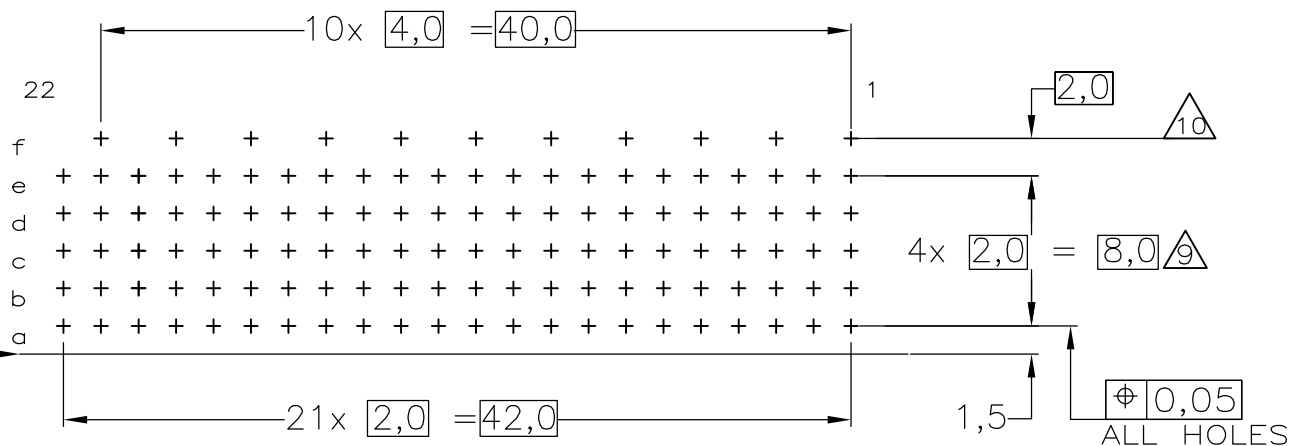
BASIC P.N. LOWERSHIELD: 352468
- 15

OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI
- 16

0.76um MIN GOLD PLATING ON MATING SURFACES



SCALE 2,5:1
COMPONENT SIDE AS SHOWN
RECOMMENDED PCB-HOLE LAY-OUT



P.C.B. HOLE DIM. ACTION PIN
FOR DETAILS SEE
APPLICATION SPECIFICATION

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN D. TRUREN	23SEP96	TE Connectivity		
DIMENSIONS: mm		CHK -	-			
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD -	-	NAME		
0 PLG ±		PRODUCT SPEC		Z-PACK 2MM HM		
1 PLG ±		108-19082		TYPE B - 22 COLUMNS		
2 PLG ±		APPLICATION SPEC		PRE-SHIELDED RECEPTACLE		
3 PLG ±		114-19029		SIZE	CAGE CODE	DRAWING NO
4 PLG ±		WEIGHT		A2	00779	C=352152
ANGLES ±		RESTRICTED CUSTOMER		SCALE	SHEET	REV
FINISH		-		NTS	1 of 1	L